# 1 Characteristics

Symbol	Parameter	Value	Unit		
V <sub>RRM</sub>	Repetitive peak reverse voltage				V
I <sub>F(AV)</sub>	Average forward current, $\delta$ = 0.5, square wave	SMB Flat, SMB Flat Notch	T <sub>L</sub> = 120 °C	3	A
		SMC	T <sub>L</sub> = 115 °C		
I <sub>FSM</sub>	Surge non repetitive forward current $t_p$ = 10 ms sinusoidal				Α
P <sub>ARM</sub>	Repetitive peak avalanche power $t_p = 10 \ \mu s, T_j = 125 \ ^{\circ}C$				W
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C		
Тj	Maximum operating junction temperature <sup>(1)</sup>	+150	°C		

#### Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

1.  $(dP_{tot'}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

#### Table 2. Thermal resistance parameter

Symbol	Parameter	Max. value	Unit	
Paran	lunation to load	SMB Flat, SMB Flat Notch	15	°C/M
R <sub>th(j-l)</sub> Junc	Junction to lead	SMC	18	°C/W

For more information, please refer to the following application note :

AN5088 : Rectifiers thermal management, handling and mounting recommendations

#### Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I_ (1)	Reverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>	-		100	μA
$I_{R}^{(1)}$		T <sub>j</sub> = 125 °C		-	16	40	mA
	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 3 A	-		0.50	V
V <sub>E</sub> <sup>(1)</sup>		T <sub>j</sub> = 125 °C		-	0.40	0.44	
VF		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 6 A	-		0.62	
		T <sub>j</sub> = 125 °C		-	0.52	0.58	

1. Pulse test:  $t_p = 380 \ \mu s, \ \delta < 2\%$ 

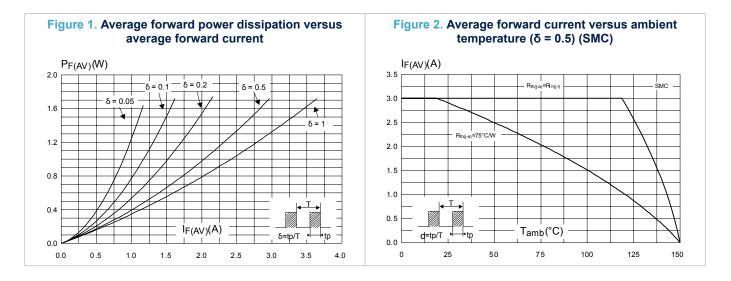
To evaluate the conduction losses, use the following equation:

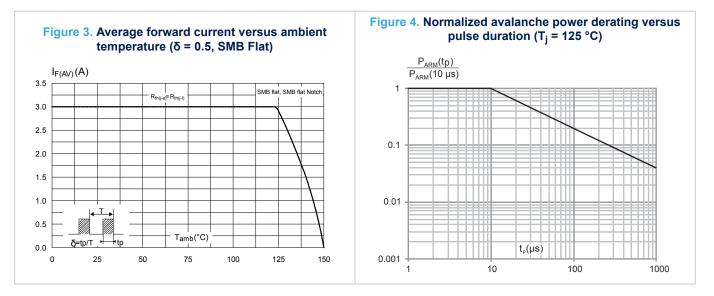
 $P = 0.30 \text{ x } I_{F(AV)} + 0.047 \text{ x } I_{F}^{2}(RMS)$ 

For more information, please refer to the following application notes related to the power losses :

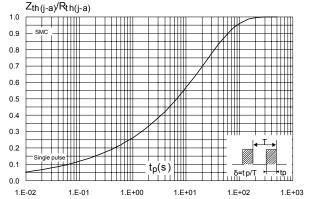
- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

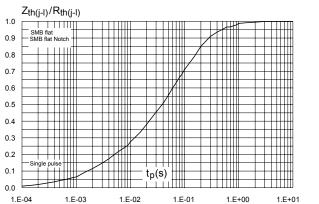
#### 1.1 **Characteristics (curves)**



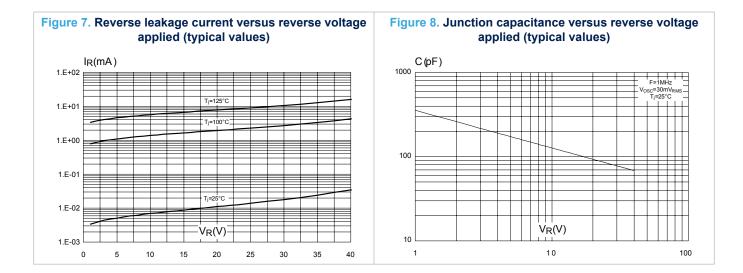


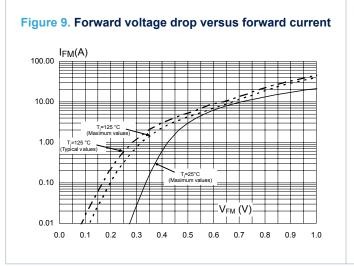




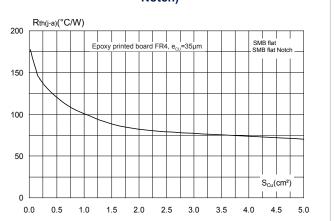




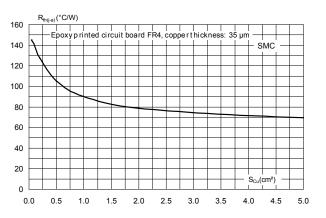












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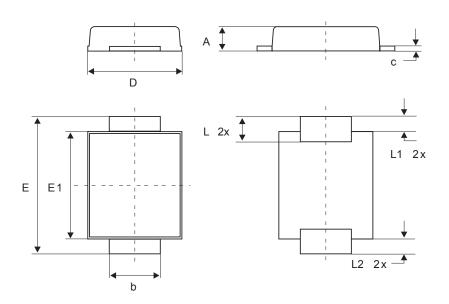
# 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMB Flat package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 12. SMB Flat package outline

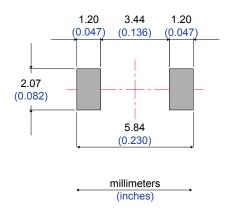


#### Table 4. SMB Flat mechanical data

	Dimensions							
Ref.	Millimeters			Inches				
	Min.	Тур.	Max.	Min.	Тур.	Max.		
А	0.90		1.10	0.035		0.044		
b	1.95		2.20	0.076		0.087		
С	0.15		0.40	0.005		0.016		
D	3.30		3.95	0.129		0.156		
E	5.10		5.60	0.200		0.221		
E1	4.05		4.60	0.159		0.182		
L	0.75		1.50	0.029		0.060		
L1		0.40			0.016			
L2		0.60			0.024			



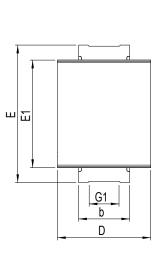


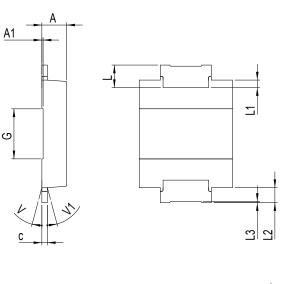


## 2.2 SMB Flat Notch package information

- Epoxy meets UL94, V0
- Lead-free package

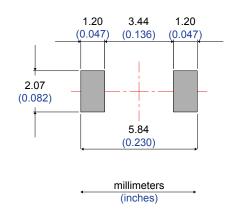
#### Figure 14. SMB Flat Notch package outline





	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.90		1.10	0.035		0.043	
A1		0.05			0.002		
b	1.95		2.20	0.077		0.087	
С	0.15		0.40	0.006		0.016	
D	3.30		3.95	0.130		0.156	
E	5.20		5.60	0.205		0.220	
E1	4.05		4.60	0.159		0.181	
G		2.00			0.079		
G1		1.20			0.047		
L	0.75		1.20	0.030		0.047	
L1		0.30			0.012		
L2		0.60			0.024		
L3	0.02			0.001			
V			8°			8°	
V1			8°			8°	

#### Table 5. SMB Flat Notch mechanical data



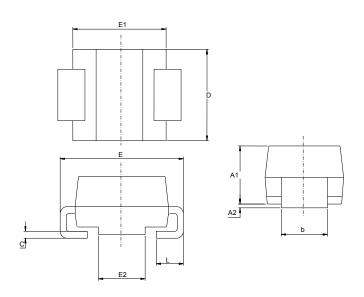
#### Figure 15. Footprint recommendations, dimensions in mm (inches)

# 2.3 SMC package information

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• Epoxy meets UL94, V0

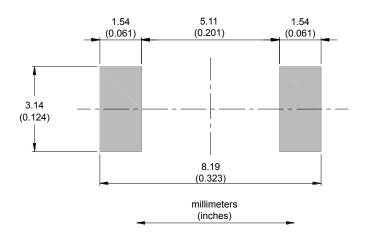
### Figure 16. SMC package outline



#### Table 6. SMC package mechanical data

	Dimensions						
Ref.	Millimeters		Inches (for re	ference only)			
	Min.	Max.	Min.	Max.			
A1	1.90	2.45	0.0748	0.0965			
A2	0.05	0.20	0.0020	0.0079			
b	2.90	3.20	0.1142	0.1260			
с	0.15	0.40	0.0059	0.0157			
D	5.55	6.25	0.2185	0.2461			
E	7.75	8.15	0.3051	0.3209			
E1	6.60	7.15	0.2598	0.2815			
E2	4.40	4.70	0.1732	0.1850			
L	0.75	1.50	0.0295	0.0591			

#### Figure 17. SMC recommended footprint



# **3** Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS3L40UFN	B34	SMB Flat Notch	0.056 g	5 000	Tape and reel
STPS3L40UF	FS3L4	SMB Flat	0.050 g	5000	Tape and reel
STPS3L40S	S3L4	SMC	0.243 g	10 000	Tape and reel

#### Table 7. Ordering information

# **Revision history**

Date	Version	Changes
Jul-2003	2A	Last update.
08-Feb-2007	3	Reformatted to current standard. Added ECOPACK statement. Added SMBflat package.
20-May-2013	4	Updated SMC package information. Updated ECOPACK statement. Corrected Y axis labels of Figure 12.
31-Jan-2020	5	Added Section 2.2 SMB Flat Notch package information.

#### Table 8. Document revision history



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